, 3 ·	ì								
		Тур	L#	Hits	Search T xt	DBs	Tim Stamp		
	1	BRS	L1	454075 9	gap or hole or space or spacing or trench	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/06/14 19:05		
	2	BRS	L2	279987 1	sacrificial or underfill or fill\$6 or oxide	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/06/14 19:05		
	3	BRS	L 3	36602	(coat\$6 or fill\$6 or inject\$6 or deposit\$6 or coat\$6) near4 (sacrificial or underfill or fill\$6 or oxide) near4 (gap or hole or space or spacing or trench)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/06/14 19:05		
	4	BRS	L4	526689	"hard mask" or "etch stop" or barrier or SiN or "silicon nitride"	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B			
	5	BRS	L 5		etch\$6 or strip\$6 or lift-off or lift\$6	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/06/14 19:06		

× ·					_	
	Туре	L #	Hits	S arch T xt	DBs	Tim Stamp
6	BRS	L6	2562		USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/06/14 19:06
7	BRS	L 7	423790	plasma or (dry near2 etch\$6)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/06/14 19:06
8	BRS	L8	581	or underfill or fill\$6 or oxide) near4 (gap or hole or space or spacing or trench)) same ("hard mask" or "etch stop" or barrier or SiN or "silicon	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/06/14 19:07
9	BRS	L9		<pre>((((coat\$6 or fill\$6 or inject\$6 or deposit\$6 or coat\$6) near4 (sacrificial or underfill or fill\$6 or oxide) near4 (gap or hole or space or spacing or trench)) same ("hard mask" or "etch stop" or barrier or SiN or "silicon nitride") same (etch\$6 or strip\$6 or lift-off or lift\$6)) same (plasma or (dry near2 etch\$6))) and (@ad<20011107)</pre>	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	